



1.0A SCHOTTKY BARRIER RECTIFIER

Product Summary

B120AE/B130AE/B140AE B120BE/B130BE/B140BE

| DIZUDE/DIJUDE/DI4UDE | | | | | |
|----------------------|--------------------|------------------------------------|-------------------------------------|--|--|
| V _{RRM} (V) | I _O (A) | V _{F(MAX)} (V) @ +25°C | I _{R(MAX)} (mA) @ +25°С | | |
| 20 | 1 | 0.5 | 0.1 | | |
| 30 | 1 | 0.5 | 0.1 | | |
| 40 | 1 | 0.5 | 0.2 | | |

Description and Applications

The Schottky rectifier providing low V_F and excellent reverse leakage stability at high temperatures, this device is ideal for use in general rectification applications such as:

- Boost Diode
- Blocking Diode
- Recirculating Diode

Features and Benefits

- Reduced Low Forward Voltage Drop (V_F); Better Efficiency and Cooler Operation
- Reduced High-temperature Reverse Leakage; Increased Reliability against Thermal Runaway Failure in High Temperature Operation
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SMA, SMB
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Finish Matte Tin Annealed over Copper Leadframe. Solderable per MIL-STD-202, Method 208 ⁽³⁾
- Polarity: Cathode Band
- Weight: SMA-0.063 grams (Approximate) SMB-0.093 grams (Approximate)

SMA/SMB



Top View



Bottom View

Ordering Information (Note 4)

| Part Number | Case | Packaging |
|-------------|------|-------------------|
| B1XXAE-13 | SMA | 5,000/Tape & Reel |
| B1XXBE-13 | SMB | 3,000/Tape & Reel |

*X = Device type, e.g. B120AE-13 (SMA package); B120BE-13 (SMB package).

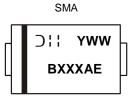
1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

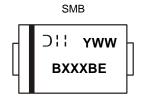
Notes:



BXXXAE = Product Type Marking Code, ex: B120AE (SMA Package) Code Marking YWW = Date Code Marking Y = Last Digit of Year (ex: 7 for 2017) WW = Week Code (01 to 53)



Marking Information (Cont.)



BXXXBE = Product Type Marking Code, ex: B120BE (SMB Package)) | = Manufacturers' Code Marking YWW = Date Code Marking Y = Last Digit of Year (ex: 7 for 2017) WW = Week Code (01 to 53)

Maximum Ratings ($@T_A = +25^{\circ}C$, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load. For capacitive load, derate current by 20%.

| Characteristic | Symbol | B120AE B120BE | B130AE B130BE | B140AE B140BE | Unit |
|---|---|------------------|------------------|------------------|------|
| Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage | V _{RRM} V _{RWM} V _{RM} | 20 | 30 | 40 | V |
| Average Rectified Output Current | lo | | 1 | | A |
| Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load | I _{FSM} | | 30 | | А |

Thermal Characteristics

| Characteristic | | Symbol | Value | Unit |
|---|------------|-----------------------------------|-------------|------|
| Typical Thermal Resistance Junction to Ambient (Note 5) | SMA SMB | R _{θJA} | 95 90 | °C/W |
| Typical Thermal Resistance Junction to Case (Note 5) | SMA SMB | R _{θJC} | 45 40 | °C/W |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -55 to +150 | °C |

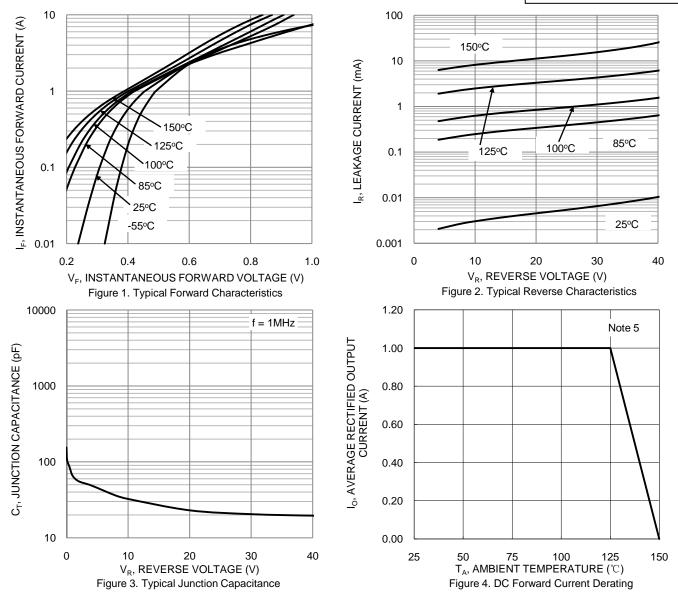
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

| Characteristic | | Symbol | Min | Тур | Max | Unit | Test Condition |
|--------------------------|---|----------------|------|--------------|------------------------|------|--|
| Forward Voltage Drop | | VF | _ | 0.45 0.40 | 0.50 | V | I _F = 1A, T _J = +25°C I _F = 1A, T _J = +125°C |
| Leakage Current (Note 6) | B120AE/B120BE B130AE/B130BE B140AE/B140BE | I _R | | 6.1 | 0.1 0.1 0.2 — | mA | $V_{R} = 20V, T_{J} = +25^{\circ}C$ $V_{R} = 30V, T_{J} = +25^{\circ}C$ $V_{R} = 40V, T_{J} = +25^{\circ}C$ $V_{R} = 40V, T_{J} = +125^{\circ}C$ |
| Typical Capacitance | | CT | | 50 | — | pF | $V_{R} = 4.0V, f = 1MHz$ |

Notes: 5. Device mounted on FR-4 substrate, 0.4" x 0.5", 2oz, single-sided, PC boards with 0.2" x 0.25" copper pad. 6. Short duration pulse test used to minimize self-heating effect.



B120AE-B140AE B120BE-B140BE

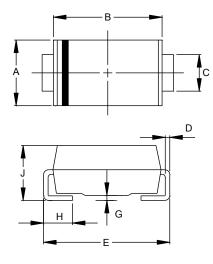




Package Outline Dimensions

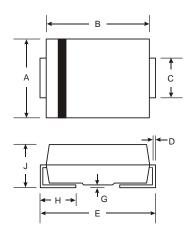
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SMA



| SMA | | | | |
|----------------------|------|------|--|--|
| Dim | Min | Max | | |
| Α | 2.29 | 2.92 | | |
| В | 4.00 | 4.60 | | |
| С | 1.27 | 1.63 | | |
| D | 0.15 | 0.31 | | |
| ш | 4.80 | 5.59 | | |
| G | 0.05 | 0.20 | | |
| Н | 0.76 | 1.52 | | |
| J | 1.96 | 2.40 | | |
| All Dimensions in mm | | | | |

(2) Package Type: SMB



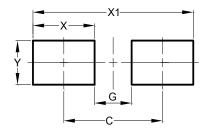
| SMB | | | | |
|----------------------|------|------|--|--|
| Dim | Min | Max | | |
| Α | 3.30 | 3.94 | | |
| в | 4.06 | 4.57 | | |
| С | 1.96 | 2.21 | | |
| D | 0.15 | 0.31 | | |
| Е | 5.00 | 5.59 | | |
| G | 0.05 | 0.20 | | |
| H | 0.76 | 1.52 | | |
| J | 2.00 | 2.50 | | |
| All Dimensions in mm | | | | |



Suggested Pad Layout

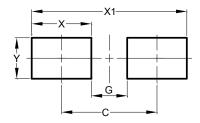
Please see http://www.diodes.com/package-outlines.html for the latest version.

(1) Package Type: SMA



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 4.00 |
| G | 1.50 |
| Х | 2.50 |
| X1 | 6.50 |
| Y | 1.70 |

(2) Package Type: SMB



| Dimensions | Value (in mm) |
|------------|---------------|
| С | 4.30 |
| G | 1.80 |
| Х | 2.50 |
| X1 | 6.80 |
| Y | 2.30 |



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